



A New Direction in Mixed-Signal

# XR8051, XR8052, XR8054

## Low Cost, High Speed Rail-to-Rail Amplifiers

### General Description

The XR8051 (single), XR8052 (dual) and XR8054 (quad) are low cost, voltage feedback amplifiers. These amplifiers are designed to operate on +3V to +5V, or  $\pm 5V$  supplies. The input voltage range extends 300mV below the negative rail and 0.9V below the positive rail.

The XR8051, XR8052, and XR8054 offer superior dynamic performance with a 260MHz small signal bandwidth and 190V/ $\mu s$  slew rate. The combination of low power, high output current drive, and rail-to-rail performance make these amplifiers well suited for battery-powered systems and video applications.

The combination of low cost and high performance make the XR8051, XR8052, and XR8054 suitable for high volume applications in both consumer and industrial applications such as video surveillance and distribution systems, professional and IPC cameras, active filter circuits, coaxial cable drivers, and electronic white boards.

### FEATURES

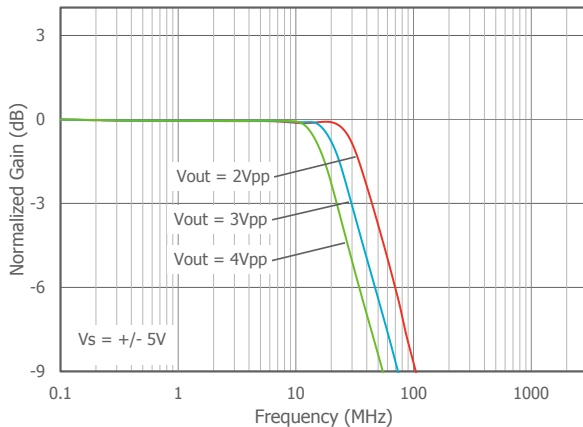
- 260MHz bandwidth
- Fully specified at +3V, +5V and  $\pm 5V$  supplies
- Output voltage range:
  - 0.03V to 4.95V;  $V_S = +5$ ;  $R_L = 2k\Omega$
- Input voltage range:
  - -0.3V to +4.1V;  $V_S = +5$
- 190V/ $\mu s$  slew rate
- 2.6mA supply current per amplifier
- $\pm 100mA$  linear output current
- $\pm 125mA$  short circuit current
- XR8051 directly replaces AD8051, AD8091
- XR8052 directly replaces AD8052, AD8092
- XR8054 directly replaces AD8054

### APPLICATIONS

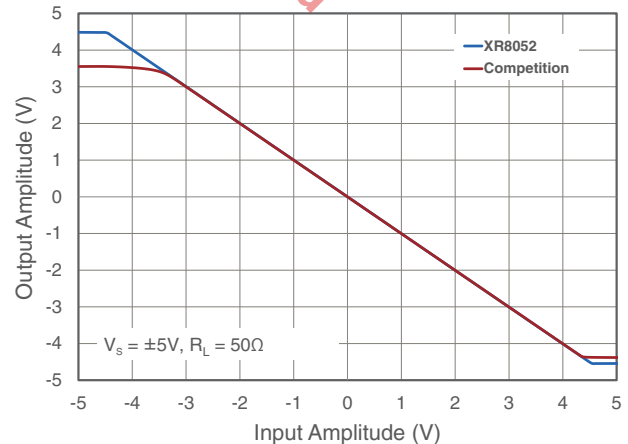
- Video driver
- Video surveillance and distribution
- A/D driver
- Active filters
- CCD imaging systems
- CD/DVD ROM
- Coaxial cable drivers
- High capacitive load driver
- Portable/battery-powered applications
- Twisted pair driver
- Telecom and optical terminals

Ordering Information - [page 26](#)

### Large Signal Frequency Response



### Output Voltage Swing vs Competition



**Absolute Maximum Ratings**

Stresses beyond the limits listed below may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.

$V_S$  ..... 0V to +14V  
 $V_{IN}$  .....  $-V_S - 0.5V$  to  $+V_S + 0.5V$

**Operating Conditions**

Supply Voltage Range ..... 2.7 to 12.6V  
 Operating Temperature Range ..... -40°C to 125°C  
 Junction Temperature ..... 150°C  
 Storage Temperature Range ..... -65°C to 170°C  
 Lead Temperature (Soldering, 10s) ..... 260°C

**Package Thermal Resistance**

$\theta_{JA}$  (TSOT-5) ..... 215°C/W  
 $\theta_{JA}$  (SOIC-8) ..... 150°C/W  
 $\theta_{JA}$  (MSOP-8) ..... 200°C/W  
 $\theta_{JA}$  (SOIC-14) ..... 90°C/W  
 $\theta_{JA}$  (TSSOP-14) ..... 100°C/W  
 Package thermal resistance ( $\theta_{JA}$ ), JEDEC standard, multi-layer test boards, still air.

**ESD Protection**

XR8051, XR8052, XR8054 (HBM) ..... 1kV  
 ESD Rating for HBM (Human Body Model).

*The product (or products) mentioned in this data sheet are no longer being manufactured and may not be ordered (OBS)*

## Electrical Characteristics at +3V

$T_A = 25^\circ\text{C}$ ,  $V_S = +3\text{V}$ ,  $R_f = 1.5\text{k}\Omega$ ,  $R_L = 2\text{k}\Omega$  to  $V_S/2$ ;  $G = 2$ ; unless otherwise noted.

Symbol	Parameter	Conditions	Min	Typ	Max	Units
Frequency Domain Response						
GBWP	-3dB Gain Bandwidth Product	$G = +11$ , $V_{OUT} = 0.2V_{pp}$		90		MHz
UGBW	Unity Gain Bandwidth	$V_{OUT} = 0.2V_{pp}$ , $R_F = 0$		245		MHz
BW <sub>SS</sub>	-3dB Bandwidth	$V_{OUT} = 0.2V_{pp}$		85		MHz
$f_{0.1dB}$	0.1dB Gain Flatness	$V_{OUT} = 0.2V_{pp}$ , $R_L = 150\Omega$		16		MHz
BW <sub>LS</sub>	Large Signal Bandwidth	$V_{OUT} = 2V_{pp}$		40		MHz
DG	Differential Gain	DC-coupled Output		0.03		%
		AC-coupled Output		0.04		%
DP	Differential Phase	DC-coupled Output		0.03		°
		AC-coupled Output		0.06		°
Time Domain						
$t_R$ , $t_F$	Rise and Fall Time	$V_{OUT} = 0.2\text{V}$ step; (10% to 90%)		5		ns
$t_S$	Settling Time to 0.1%	$V_{OUT} = 1\text{V}$ step		25		ns
OS	Overshoot	$V_{OUT} = 0.2\text{V}$ step		8		%
SR	Slew Rate	$G = -1$ , $2\text{V}$ step		165		V/ $\mu\text{s}$
Distortion/Noise Response						
THD	Total Harmonic Distortion	1MHz, $V_{OUT} = 1V_{pp}$		75		dBc
$e_n$	Input Voltage Noise	>50kHz		16		nV/ $\sqrt{\text{Hz}}$
X <sub>TALK</sub>	Crosstalk	f = 5MHz		58		dB
DC Performance						
$V_{IO}$	Input Offset Voltage			0.5		mV
$d_{VIO}$	Average Drift			5		$\mu\text{V}/^\circ\text{C}$
$I_B$	Input Bias Current			1.4		$\mu\text{A}$
$dI_B$	Average Drift			2		nA/ $^\circ\text{C}$
$I_{OS}$	Input Offset Current			0.05		$\mu\text{A}$
PSRR	Power Supply Rejection Ratio	DC		102		dB
$A_{OL}$	Open Loop Gain	$R_L = 2\text{k}\Omega$		92		dB
$I_S$	Supply Current	per channel		2.6		mA
Input Characteristics						
$C_{IN}$	Input Capacitance			0.5		pF
CMIR	Common Mode Input Range			-0.3 to 2.1		V
CMRR	Common Mode Rejection Ratio	DC, $V_{CM} = 0$ to 1.5V		100		dB
Output Characteristics						
$V_{OUT}$	Output Swing	$R_L = 150\Omega$		0.3 to 2.75		V
		$R_L = 2\text{k}\Omega$		0.02 to 2.96		V
$I_{OUT}$	Output Current			$\pm 100$		mA
$I_{SC}$	Short Circuit Current	$V_{OUT} = V_S / 2$		$\pm 125$		V
$V_S$	Power Supply Operating Range			2.7 to 12.6		V

## Electrical Characteristics at +5V

$T_A = 25^\circ\text{C}$ ,  $V_S = +5\text{V}$ ,  $R_f = 1.5\text{k}\Omega$ ,  $R_L = 2\text{k}\Omega$  to  $V_S/2$ ;  $G = 2$ ; unless otherwise noted.

Symbol	Parameter	Conditions	Min	Typ	Max	Units
Frequency Domain Response						
GBWP	-3dB Gain Bandwidth Product	$G = +11$ , $V_{OUT} = 0.2V_{pp}$		95		MHz
UGBW	Unity Gain Bandwidth	$V_{OUT} = 0.2V_{pp}$ , $R_F = 0$		250		MHz
BW <sub>SS</sub>	-3dB Bandwidth	$V_{OUT} = 0.2V_{pp}$		85		MHz
$f_{0.1dB}$	0.1dB Gain Flatness	$V_{OUT} = 0.2V_{pp}$ , $R_L = 150\Omega$		35		MHz
BW <sub>LS</sub>	Large Signal Bandwidth	$V_{OUT} = 2V_{pp}$		45		MHz
DG	Differential Gain	DC-coupled Output		0.03		%
		AC-coupled Output		0.04		%
DP	Differential Phase	DC-coupled Output		0.03		°
		AC-coupled Output		0.06		°
Time Domain						
$t_R$ , $t_F$	Rise and Fall Time	$V_{OUT} = 0.2\text{V}$ step		5		ns
$t_S$	Settling Time to 0.1%	$V_{OUT} = 2\text{V}$ step		25		ns
OS	Overshoot	$V_{OUT} = 0.2\text{V}$ step		5		%
SR	Slew Rate	$G = -1$ , $4\text{V}$ step		185		V/ $\mu\text{s}$
Distortion/Noise Response						
THD	Total Harmonic Distortion	1MHz, $V_{OUT} = 2V_{pp}$		-75		dBc
$e_n$	Input Voltage Noise	>50kHz		16		nV/ $\sqrt{\text{Hz}}$
X <sub>TALK</sub>	Crosstalk	$f = 5\text{MHz}$		58		dB
DC Performance						
$V_{IO}$	Input Offset Voltage		-7	0.5	7	mV
$d_{VIO}$	Average Drift			5		$\mu\text{V}/^\circ\text{C}$
$I_B$	Input Bias Current		-2	1.4	2	$\mu\text{A}$
$dI_B$	Average Drift			2		nA/ $^\circ\text{C}$
$I_{OS}$	Input Offset Current		-0.75	0.05	0.75	$\mu\text{A}$
PSRR	Power Supply Rejection Ratio	DC	80	102		dB
$A_{OL}$	Open Loop Gain	$R_L = 2\text{k}\Omega$	80	92		dB
$I_S$	Supply Current	per channel		2.6	4	mA
Input Characteristics						
$C_{IN}$	Input Capacitance			0.5		pF
CMIR	Common Mode Input Range			-0.3 to 4.1		V
CMRR	Common Mode Rejection Ratio	DC, $V_{CM} = 0$ to $3.5\text{V}$	75	100		dB
Output Characteristics						
$V_{OUT}$	Output Swing	$R_L = 150\Omega$	0.35	0.1 to 4.9	4.65	V
		$R_L = 2\text{k}\Omega$		0.03 to 4.95		V
$I_{OUT}$	Output Current			$\pm 100$		mA
$I_{SC}$	Short Circuit Current	$V_{OUT} = V_S / 2$		$\pm 125$		V
$V_S$	Power Supply Operating Range			2.7 to 12.6		V

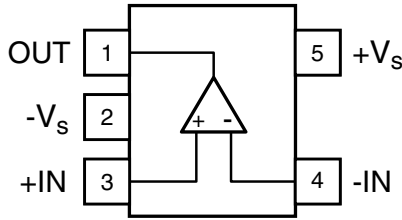
## Electrical Characteristics at $\pm 5V$

$T_A = 25^\circ C$ ,  $V_S = \pm 5V$ ,  $R_f = 1.5k\Omega$ ,  $R_L = 2k\Omega$  to GND;  $G = 2$ ; unless otherwise noted.

Symbol	Parameter	Conditions	Min	Typ	Max	Units
Frequency Domain Response						
GBWP	-3dB Gain Bandwidth Product	$G = +11$ , $V_{OUT} = 0.2V_{pp}$		90		MHz
UGBW	Unity Gain Bandwidth	$V_{OUT} = 0.2V_{pp}$ , $R_F = 0$		260		MHz
BW <sub>SS</sub>	-3dB Bandwidth	$V_{OUT} = 0.2V_{pp}$		85		MHz
$f_{0.1dB}$	0.1dB Gain Flatness	$V_{OUT} = 0.2V_{pp}$ , $R_L = 150\Omega$		22		MHz
BW <sub>LS</sub>	Large Signal Bandwidth	$V_{OUT} = 2V_{pp}$		50		MHz
DG	Differential Gain	DC-coupled Output		0.03		%
		AC-coupled Output		0.04		%
DP	Differential Phase	DC-coupled Output		0.03		°
		AC-coupled Output		0.06		°
Time Domain						
$t_R$ , $t_F$	Rise and Fall Time	$V_{OUT} = 0.2V$ step		5		ns
$t_S$	Settling Time to 0.1%	$V_{OUT} = 2V$ step, $R_L = 100\Omega$		25		ns
OS	Overshoot	$V_{OUT} = 0.2V$ step		5		%
SR	Slew Rate	$G = -1$ , $5V$ step		190		V/ $\mu s$
Distortion/Noise Response						
THD	Total Harmonic Distortion	1MHz, $V_{OUT} = 2V_{pp}$		76		dBc
$e_n$	Input Voltage Noise	>50kHz		16		nV/ $\sqrt{Hz}$
X <sub>TALK</sub>	Crosstalk	$f = 5MHz$		58		dB
DC Performance						
$V_{IO}$	Input Offset Voltage			0.5		mV
$d_{VIO}$	Average Drift			5		$\mu V/^\circ C$
$I_B$	Input Bias Current			1.3		$\mu A$
$dI_B$	Average Drift			2		nA/ $^\circ C$
$I_{OS}$	Input Offset Current			0.04		$\mu A$
PSRR	Power Supply Rejection Ratio	DC		102		dB
$A_{OL}$	Open Loop Gain	$R_L = 2k\Omega$		92		dB
$I_S$	Supply Current	per channel		2.6		mA
Input Characteristics						
$C_{IN}$	Input Capacitance			0.5		pF
CMIR	Common Mode Input Range			-5.3 to 4.1		V
CMRR	Common Mode Rejection Ratio	DC, $V_{CM} = -5$ to $3.5V$		100		dB
Output Characteristics						
$V_{OUT}$	Output Swing	$R_L = 150\Omega$		-4.8 to 4.8		V
		$R_L = 2k\Omega$		-4.95 to 4.93		V
$I_{OUT}$	Output Current			$\pm 100$		mA
$I_{SC}$	Short Circuit Current	$V_{OUT} = V_S / 2$		$\pm 125$		V
$V_S$	Power Supply Operating Range			2.7 to 12.6		V

**XR8051 Pin Configurations**

TSOT-5

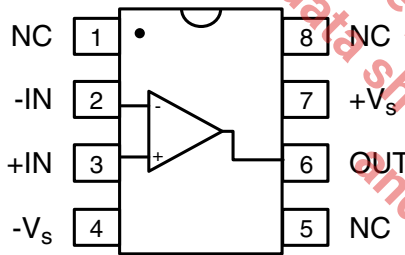


**XR8051 Pin Assignments**

TSOT-5

Pin No.	Pin Name	Description
1	OUT	Output
2	-Vs	Negative supply
3	+IN	Positive input
4	-IN	Negative input
5	+Vs	Positive supply

SOIC-8

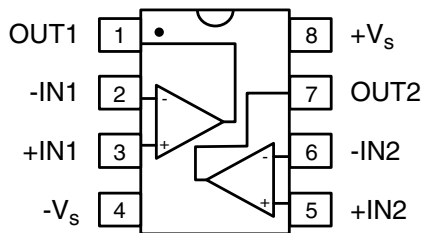


SOIC-8

Pin No.	Pin Name	Description
1	NC	No Connect
2	-IN	Negative input
3	+IN	Positive input
4	-Vs	Negative supply
5	NC	No Connect
6	OUT	Output
7	+Vs	Positive supply
8	NC	No Connect

**XR8052 Pin Configuration**

SOIC-8 / MSOP-8



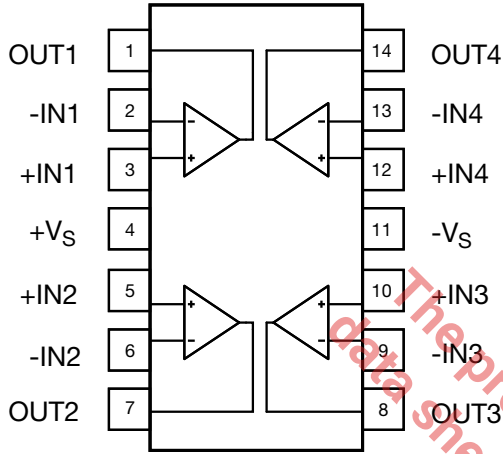
**XR8052 Pin Assignments**

SOIC-8 / MSOP-8

Pin No.	Pin Name	Description
1	OUT1	Output, channel 1
2	-IN1	Negative input, channel 1
3	+IN1	Positive input, channel 1
4	-Vs	Negative supply
5	+IN2	Positive input, channel 2
6	-IN2	Negative input, channel 2
7	OUT2	Output, channel 2
8	+Vs	Positive supply

**XR8054 Pin Configuration**

SOIC-14 / TSSOP-14



**XR8054 Pin Assignments**

SOIC-14 / TSSOP-14

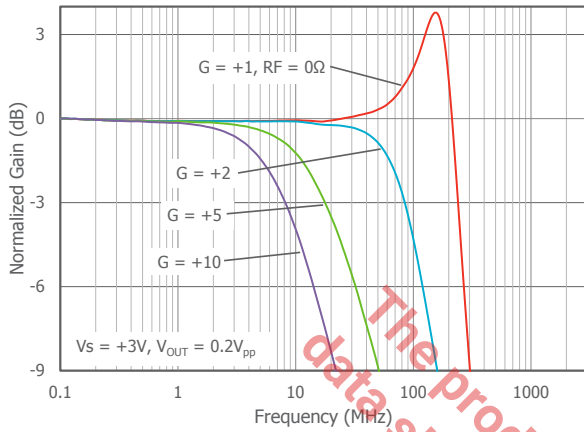
Pin No.	Pin Name	Description
1	OUT1	Output, channel 1
2	-IN1	Negative input, channel 1
3	+IN1	Positive input, channel 1
4	+Vs	Positive supply
5	+IN2	Positive input, channel 2
6	-IN2	Negative input, channel 2
7	OUT2	Output, channel 2
8	OUT3	Output, channel 3
9	-IN3	Negative input, channel 3
10	+IN3	Positive input, channel 3
11	-Vs	Negative supply
12	+IN4	Positive input, channel 4
13	-IN4	Negative input, channel 4
14	OUT4	Output, channel 4

This product (or products) mentioned in this data sheet are no longer being manufactured and may not be ordered (OBS)

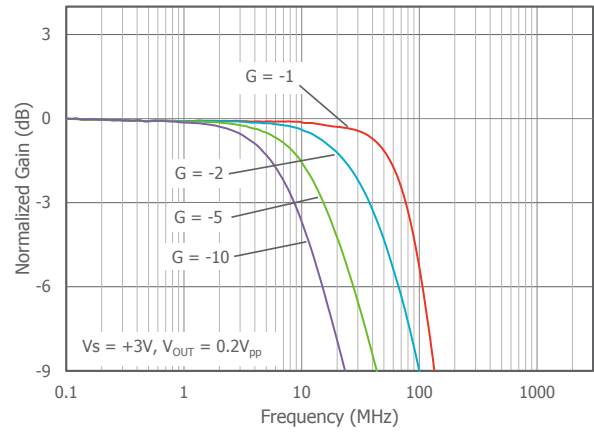
### Typical Performance Characteristics

$T_A = 25^\circ\text{C}$ ,  $V_S = +3\text{V}$ ,  $R_L = 2\text{k}\Omega$  to  $V_S/2$ ,  $G = +2$ ,  $R_F = 1.5\text{k}\Omega$ ; unless otherwise noted.

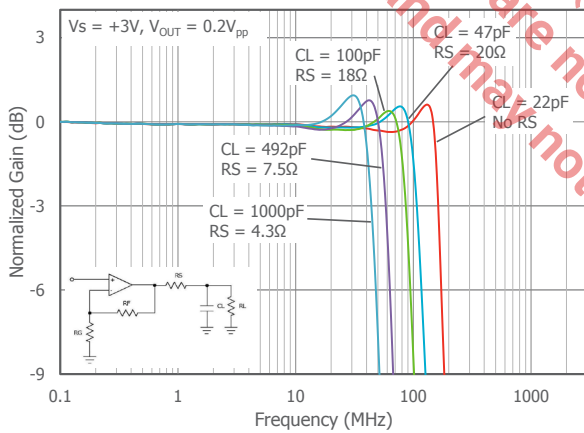
Non-Inverting Freq. Resp.



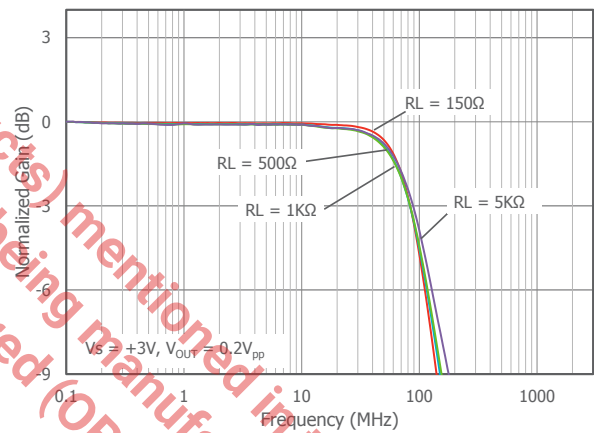
Inverting Freq. Resp.



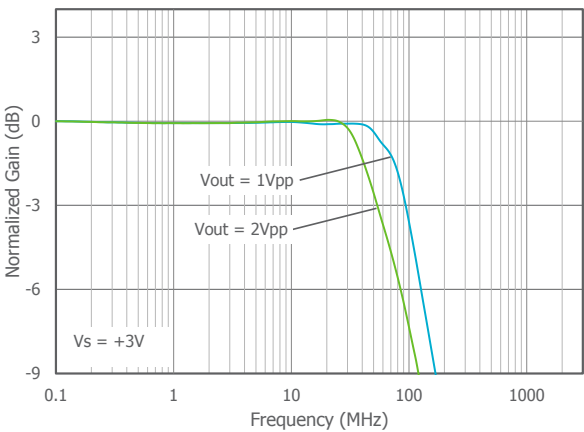
Freq. Resp. vs  $C_L$



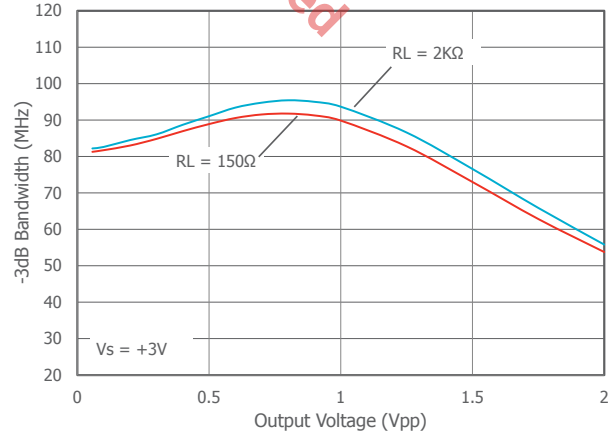
Freq. Resp. vs  $R_L$



Large Signal Freq. Resp.



-3dB BW vs Output Voltage

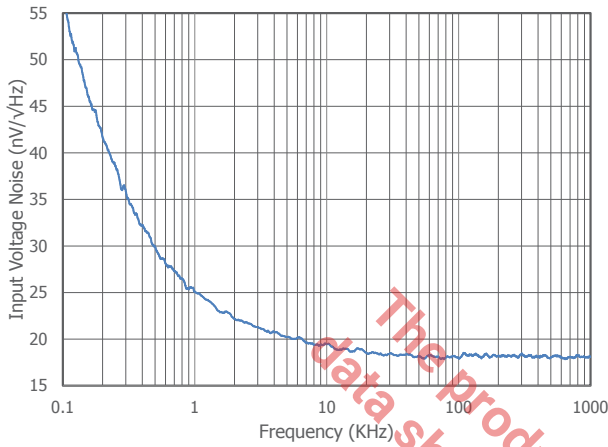




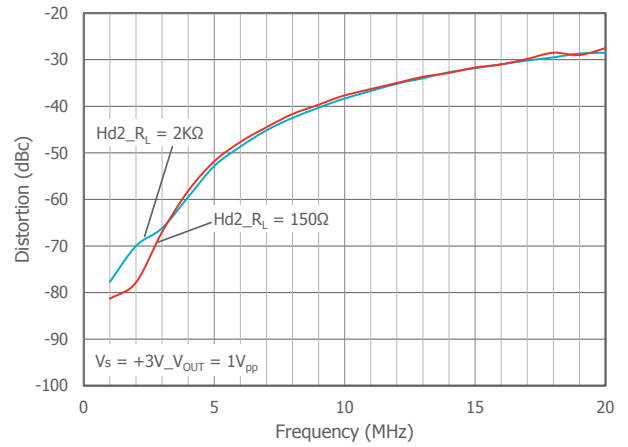
### Typical Performance Characteristics

$T_A = 25^\circ\text{C}$ ,  $V_S = +3\text{V}$ ,  $R_L = 2\text{k}\Omega$  to  $V_S/2$ ,  $G = +2$ ,  $R_F = 1.5\text{k}\Omega$ ; unless otherwise noted.

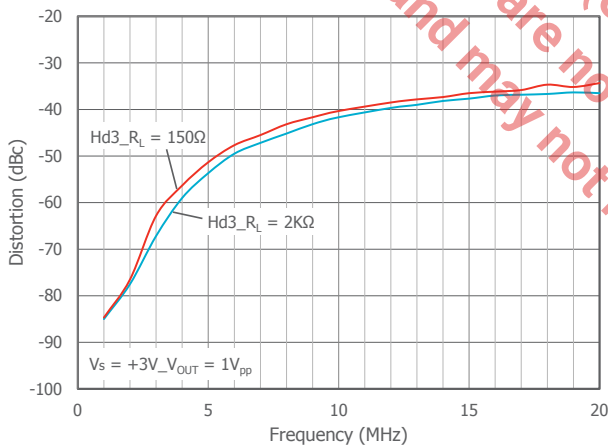
Input Voltage Noise vs Freq.



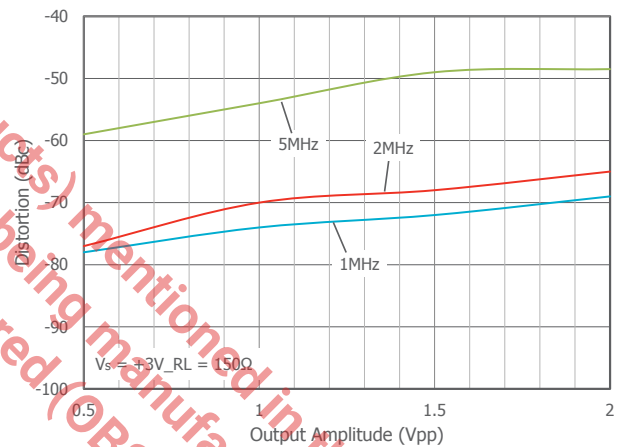
2nd Harmonic Distortion vs  $R_L$  over Freq.



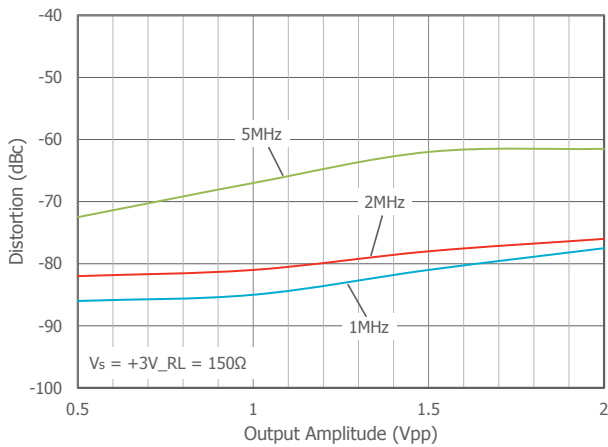
3rd Harmonic Distortion vs  $R_L$  over Freq.



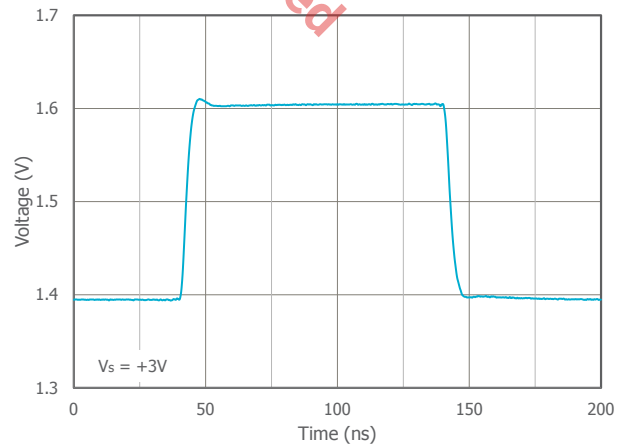
2nd Harmonic Distortion vs  $V_O$  over Freq.



3rd Harmonic Distortion vs  $V_O$  over Freq.



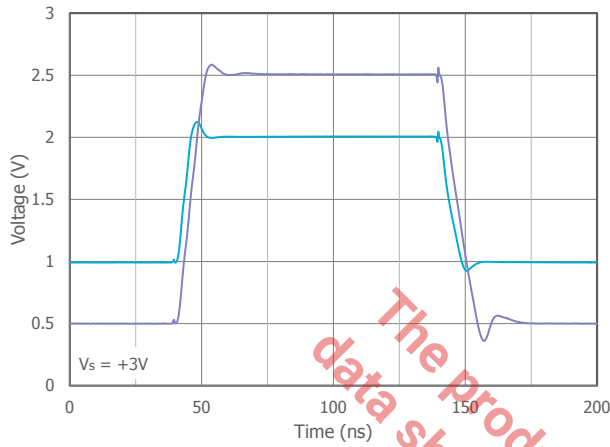
Non-Inverting Small Signal Pulse Response



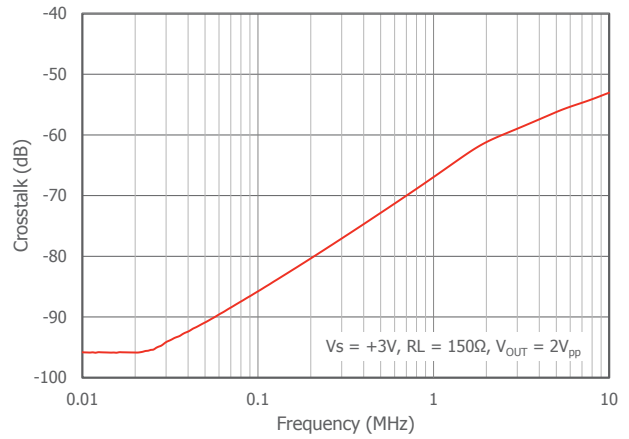
### Typical Performance Characteristics

$T_A = 25^\circ\text{C}$ ,  $V_S = +3\text{V}$ ,  $R_L = 2\text{k}\Omega$  to  $V_S/2$ ,  $G = +2$ ,  $R_F = 1.5\text{k}\Omega$ ; unless otherwise noted.

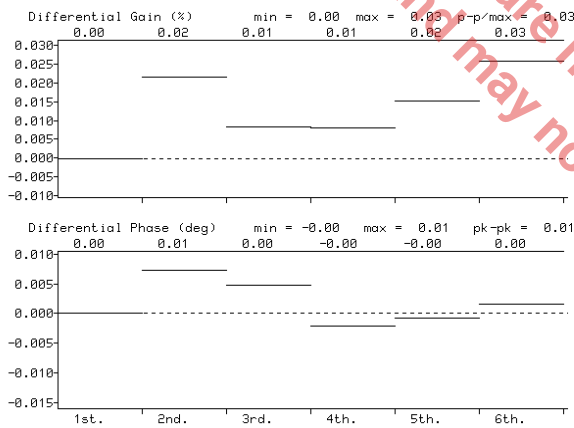
Non-Inverting Large Signal Pulse Response



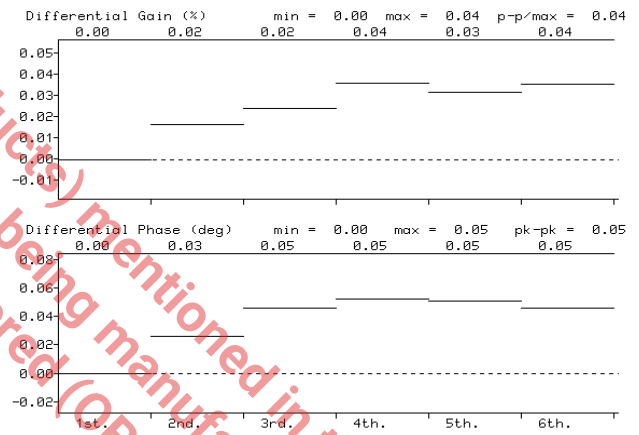
Crosstalk vs Frequency (XR8052)



Differential Gain & Phase\_DC Coupled



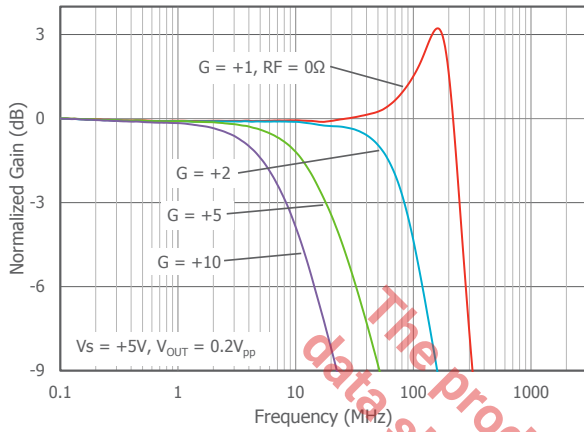
Differential Gain & Phase\_AC Coupled



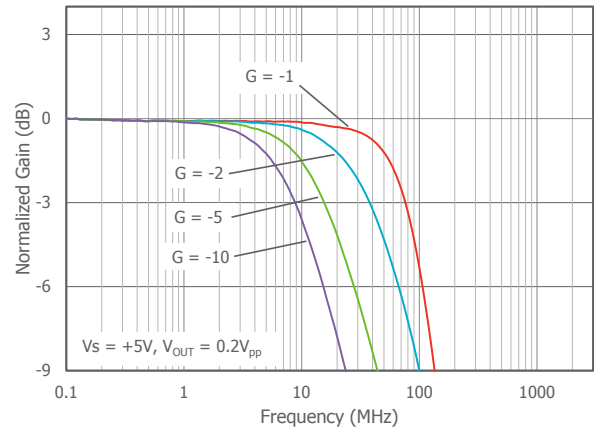
**Typical Performance Characteristics**

$T_A = 25^\circ\text{C}$ ,  $V_S = +5\text{V}$ ,  $R_L = 2\text{k}\Omega$  to  $V_S/2$ ,  $G = +2$ ,  $R_F = 1.5\text{k}\Omega$ ; unless otherwise noted.

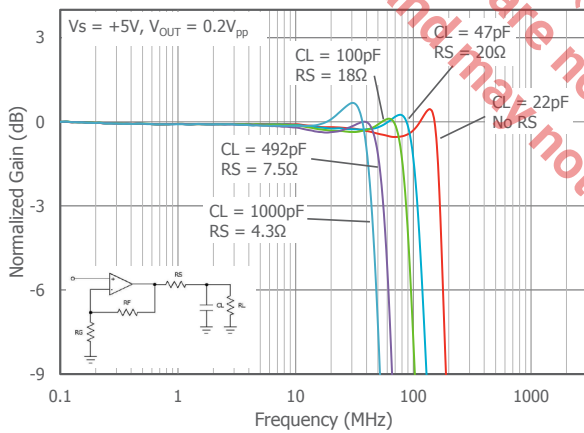
Non-Inverting Freq. Resp.



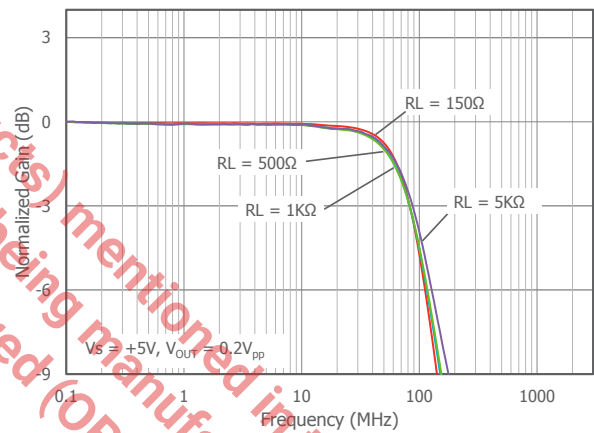
Inverting Freq. Resp.



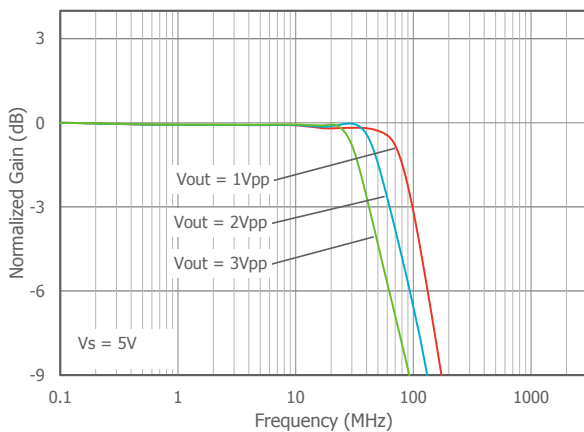
Freq. Resp. vs  $C_L$



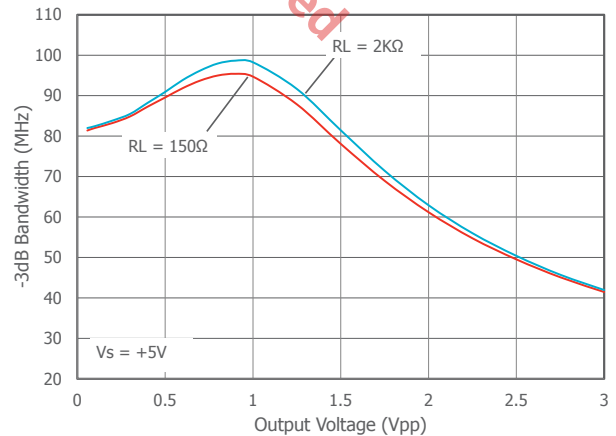
Freq. Resp. vs  $R_L$



Large Signal Freq. Resp.



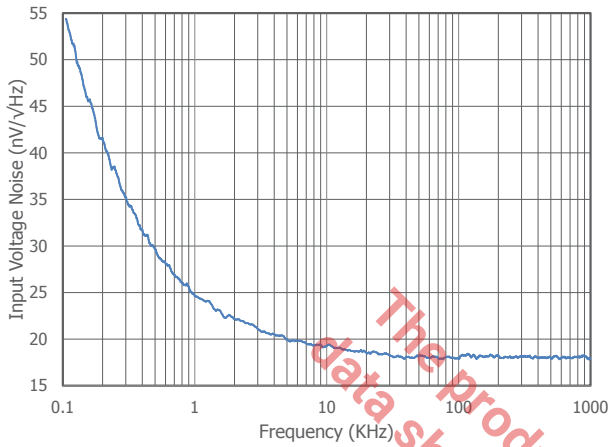
-3dB BW vs Output Voltage



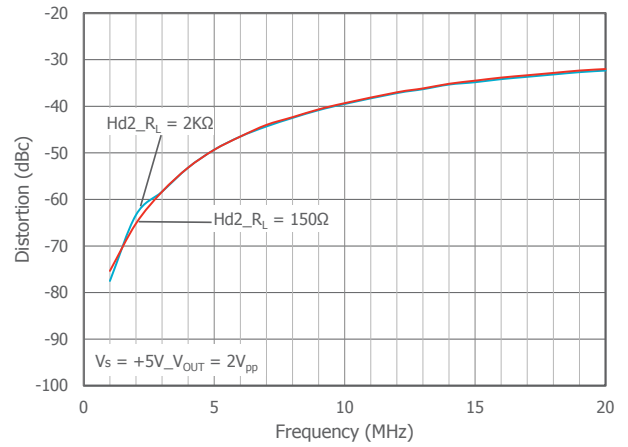
### Typical Performance Characteristics

$T_A = 25^\circ\text{C}$ ,  $V_S = +5\text{V}$ ,  $R_L = 2\text{k}\Omega$  to  $V_S/2$ ,  $G = +2$ ,  $R_F = 1.5\text{k}\Omega$ ; unless otherwise noted.

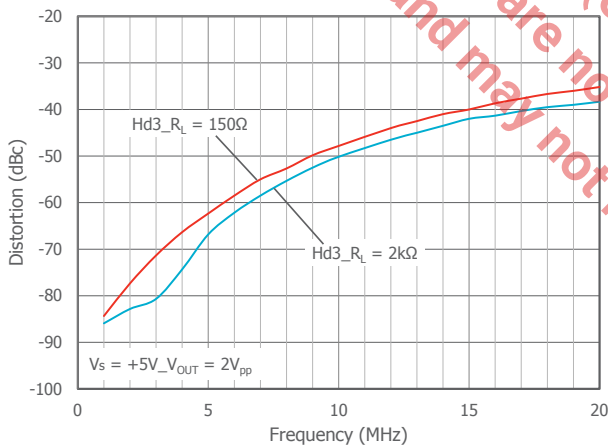
Input Voltage Noise vs Freq.



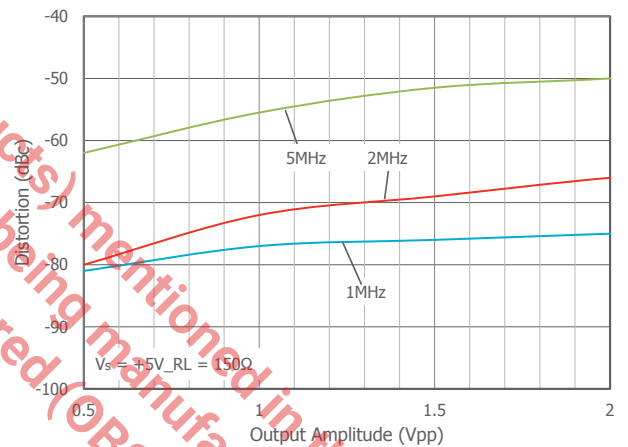
2nd Harmonic Distortion vs  $R_L$  over Freq.



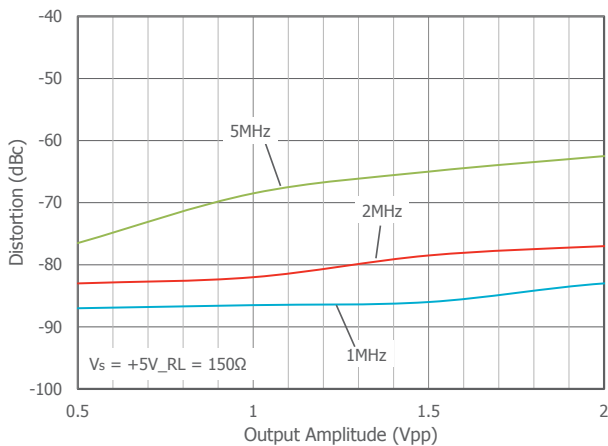
3rd Harmonic Distortion vs  $R_L$  over Freq.



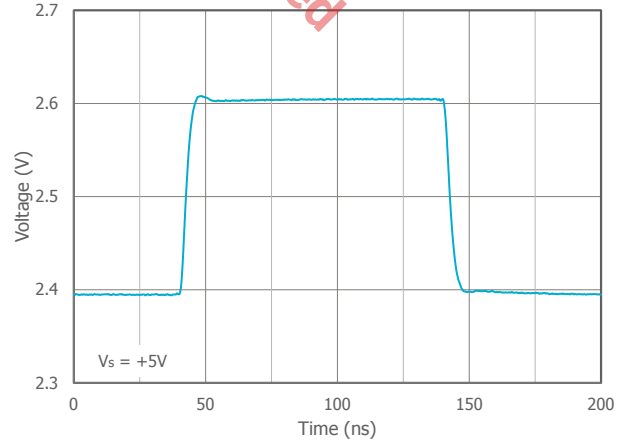
2nd Harmonic Distortion vs  $V_O$  over Freq.



3rd Harmonic Distortion vs  $V_O$  over Freq.



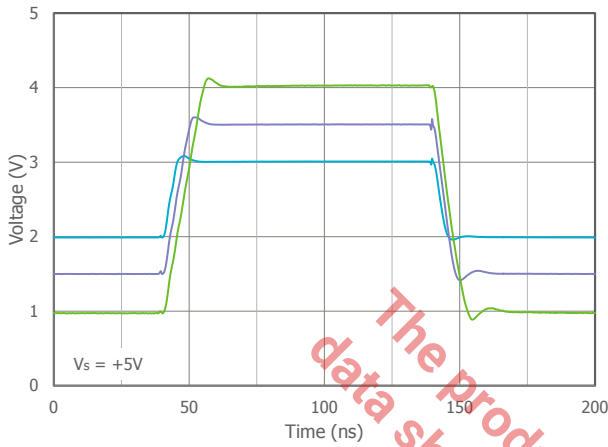
Non-Inverting Small Signal Pulse Response



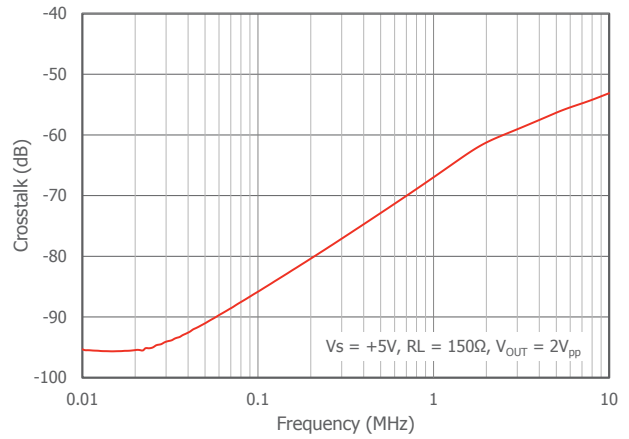
**Typical Performance Characteristics**

$T_A = 25^\circ\text{C}$ ,  $V_S = +5\text{V}$ ,  $R_L = 2\text{k}\Omega$  to  $V_S/2$ ,  $G = +2$ ,  $R_F = 1.5\text{k}\Omega$ ; unless otherwise noted.

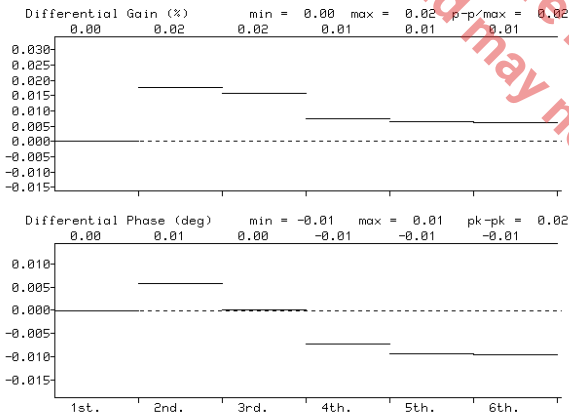
Non-Inverting Large Signal Pulse Response



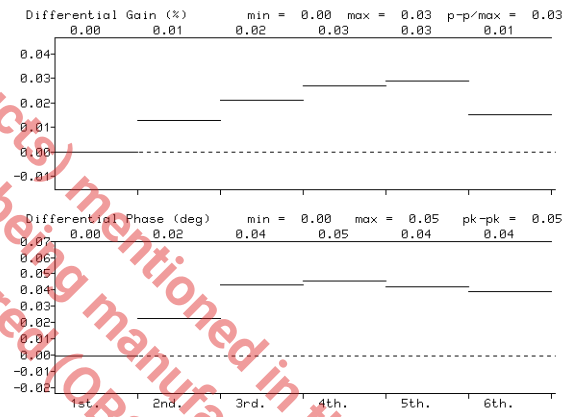
Crosstalk vs Frequency (XR8052)



Differential Gain & Phase\_DC Coupled



Differential Gain & Phase\_AC Coupled

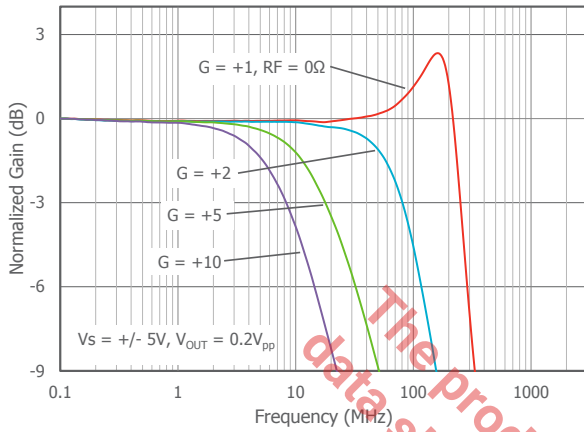


The product (or products) mentioned in this data sheet are no longer being manufactured (OBS) and may not be ordered.

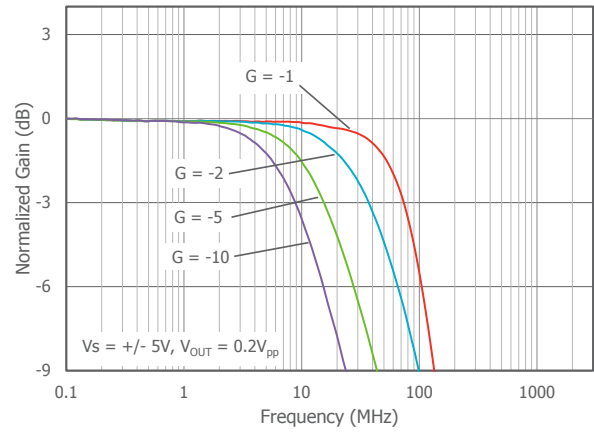
**Typical Performance Characteristics**

$T_A = 25^\circ\text{C}$ ,  $V_S = \pm 5\text{V}$ ,  $R_L = 2\text{k}\Omega$  to GND,  $G = +2$ ,  $R_F = 1.5\text{k}\Omega$ ; unless otherwise noted.

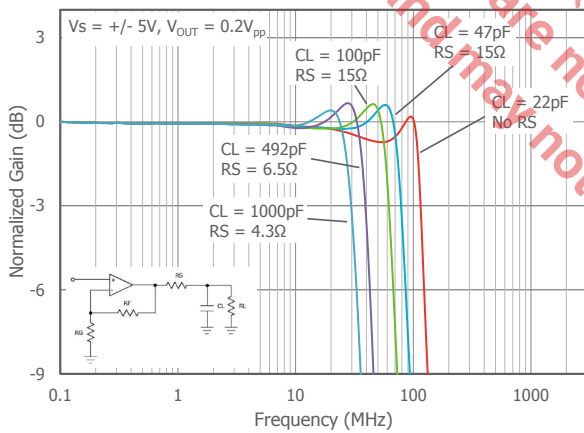
Non-Inverting Freq. Resp.



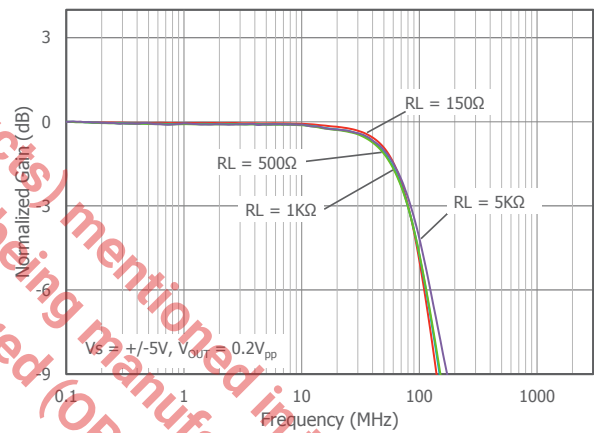
Inverting Freq. Resp.



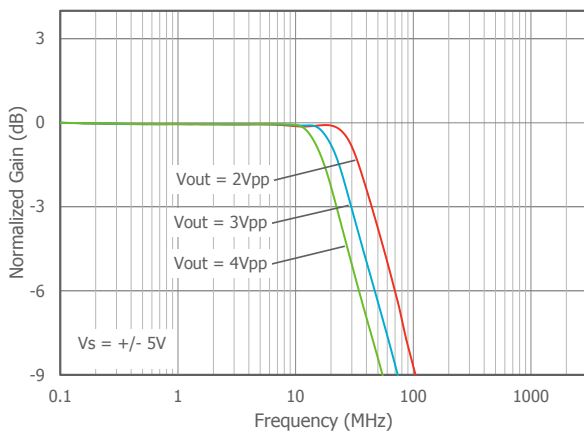
Freq. Resp. vs  $C_L$



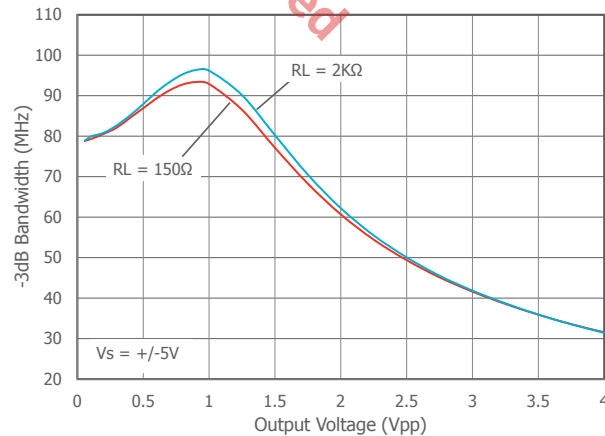
Freq. Resp. vs  $R_L$



Large Signal Freq. Resp.



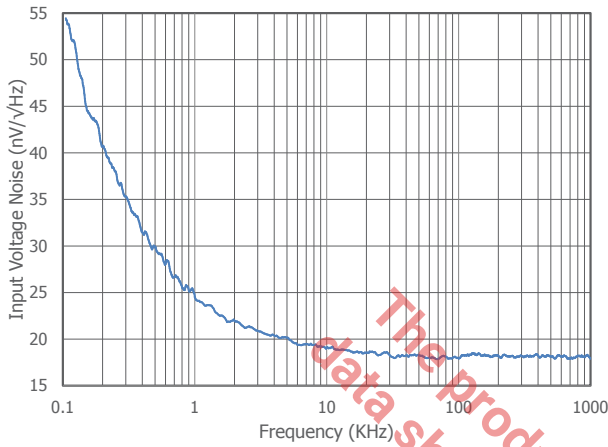
-3dB BW vs Output Voltage



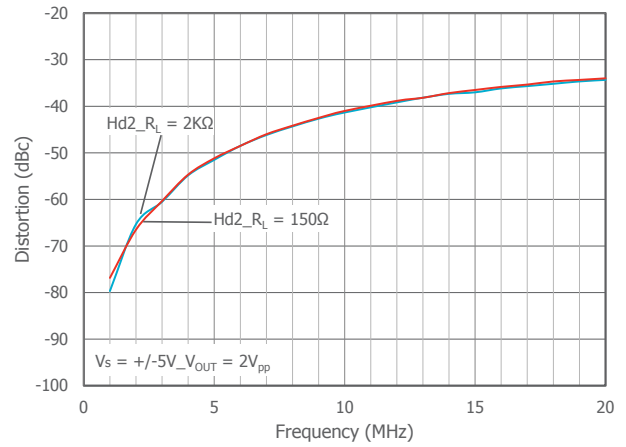
### Typical Performance Characteristics

$T_A = 25^\circ\text{C}$ ,  $V_S = \pm 5\text{V}$ ,  $R_L = 2\text{k}\Omega$  to GND,  $G = +2$ ,  $R_F = 1.5\text{k}\Omega$ ; unless otherwise noted.

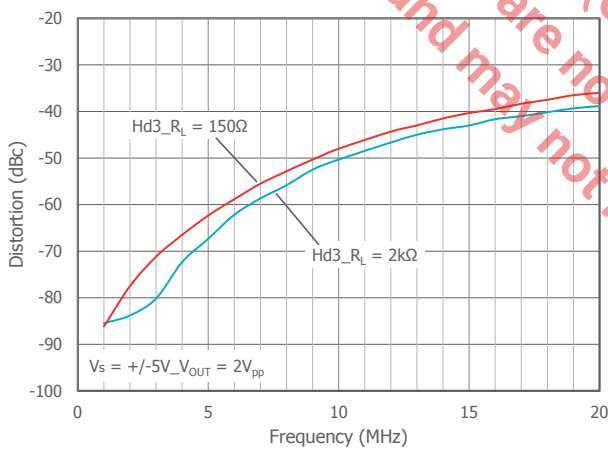
Input Voltage Noise vs Freq.



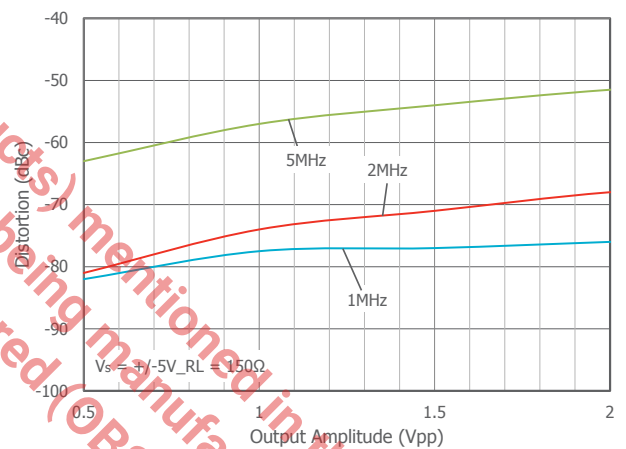
2nd Harmonic Distortion vs  $R_L$  over Freq.



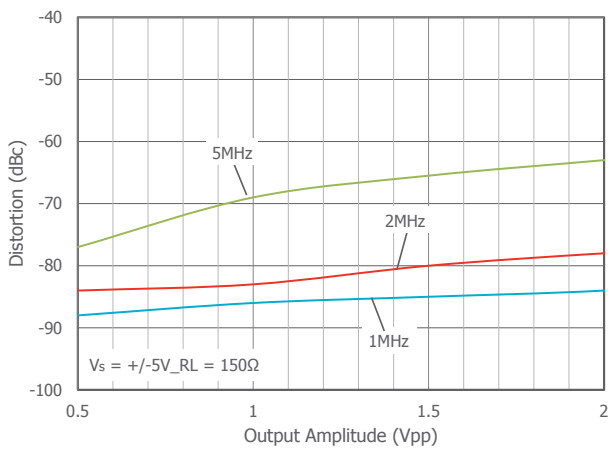
3rd Harmonic Distortion vs  $R_L$  over Freq.



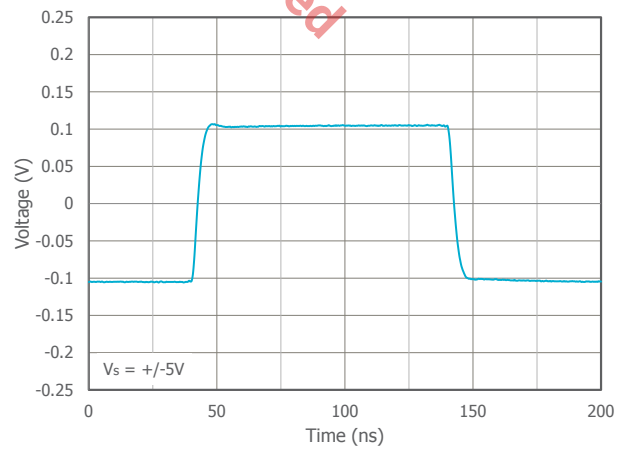
2nd Harmonic Distortion vs  $V_O$  over Freq.



3rd Harmonic Distortion vs  $V_O$  over Freq.



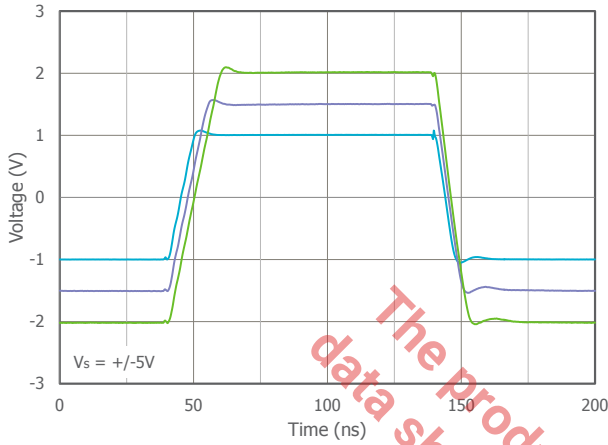
Non-Inverting Small Signal Pulse Response



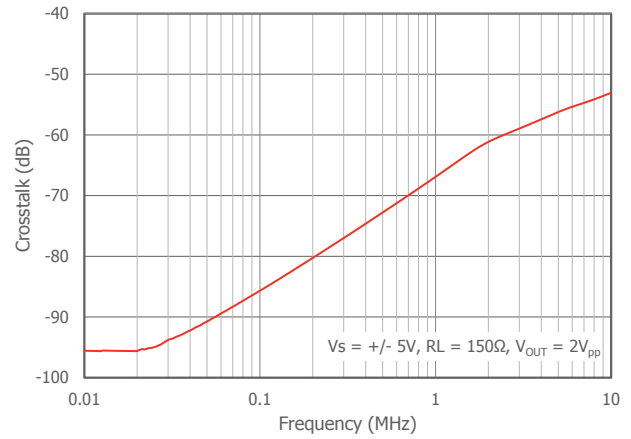
### Typical Performance Characteristics

$T_A = 25^\circ\text{C}$ ,  $V_S = \pm 5\text{V}$ ,  $R_L = 2\text{k}\Omega$  to GND,  $G = +2$ ,  $R_F = 1.5\text{k}\Omega$ ; unless otherwise noted.

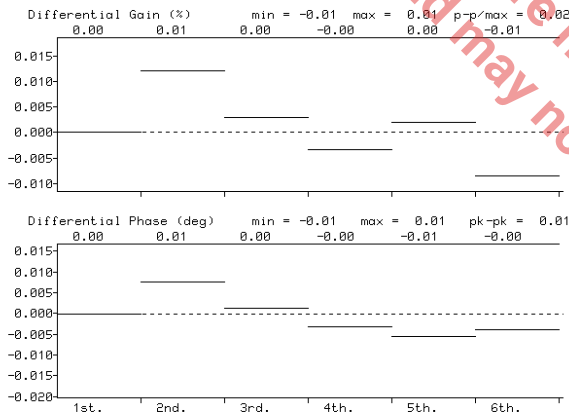
Non-Inverting Large Signal Pulse Response



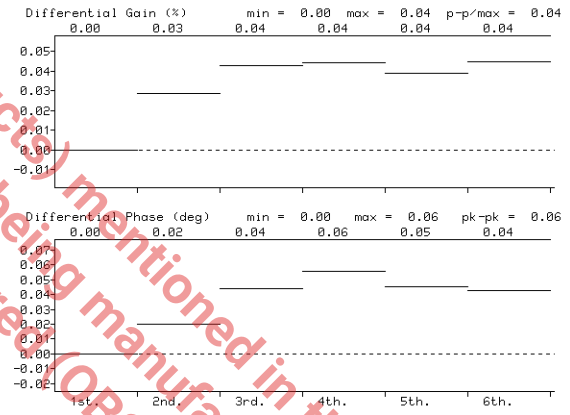
Crosstalk vs Frequency (XR8052)



Differential Gain & Phase\_DC Coupled



Differential Gain & Phase\_AC Coupled



The Product (or product) mentioned in this data sheet are no longer being manufactured (OBS) and may not be ordered.



## Application Information

### General Description

The XR8051, XR8052, and XR8054 are single supply, general purpose, voltage-feedback amplifiers fabricated on a complementary bipolar process using a patent pending topography. They feature a rail-to-rail output stage and is unity gain stable.

The common mode input range extends to 300mV below ground and to 0.9V below  $V_s$ . Exceeding these values will not cause phase reversal. However, if the input voltage exceeds the rails by more than 0.5V, the input ESD devices will begin to conduct. The output will stay at the rail during this overdrive condition.

The design is short circuit protected and offers “soft” saturation protection that improves recovery time.

Figures 1, 2, and 3 illustrate typical circuit configurations for non-inverting, inverting, and unity gain topologies for dual supply applications. They show the recommended bypass capacitor values and overall closed loop gain equations. Figure 4 shows the typical non-inverting gain circuit for single supply applications.

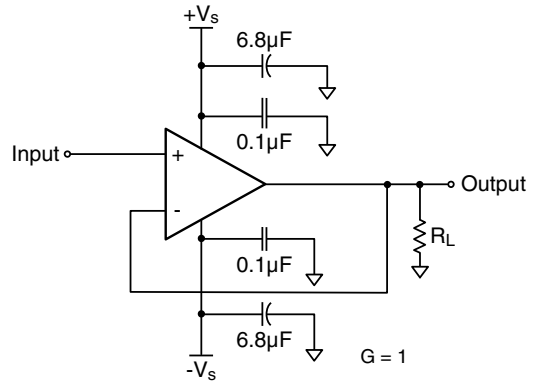


Figure 3: Unity Gain Circuit

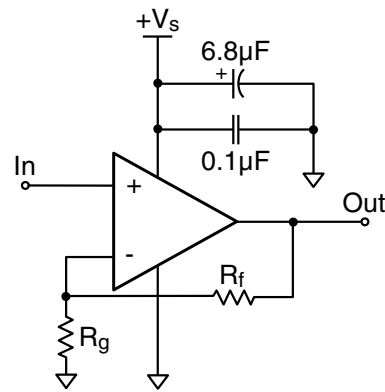


Figure 4: Single Supply Non-Inverting Gain Circuit

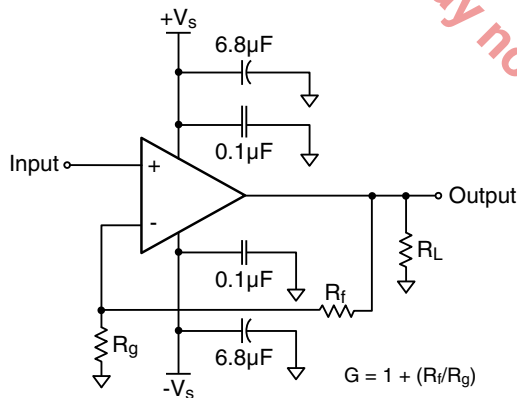


Figure 1: Typical Non-Inverting Gain Circuit

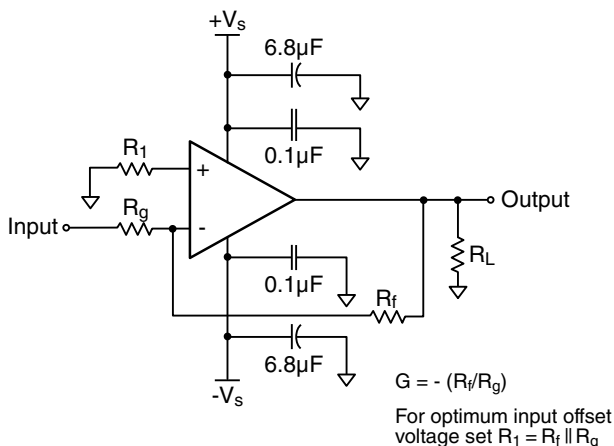


Figure 2: Typical Inverting Gain Circuit

### Overdrive Recovery

For an amplifier, an overdrive condition occurs when the output (and/or) input ranges are exceeded. The recovery time varies based on whether the input or output is overdriven and by how much the ranges are exceeded. The XR8051, XR8052, and XR8054 will typically recover in less than 20ns from an overdrive condition. Figure 5 shows the XR8052 in an overdriven condition.

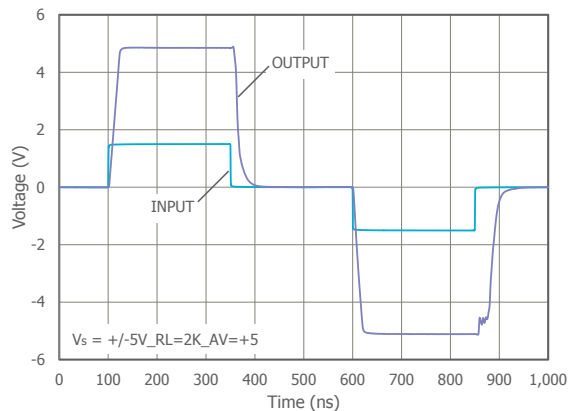


Figure 5: Overdrive Recovery

**Power Dissipation**

Power dissipation should not be a factor when operating under the stated 2kΩ load condition. However, applications with low impedance, DC coupled loads should be analyzed to ensure that maximum allowed junction temperature is not exceeded. Guidelines listed below can be used to verify that the particular application will not cause the device to operate beyond its intended operating range.

Maximum power levels are set by the absolute maximum junction rating of 170°C. To calculate the junction temperature, the package thermal resistance value  $\theta_{JA}$  ( $\theta_{JA}$ ) is used along with the total die power dissipation.

$$T_{\text{Junction}} = T_{\text{Ambient}} + (\theta_{JA} \times P_D)$$

Where  $T_{\text{Ambient}}$  is the temperature of the working environment.

In order to determine  $P_D$ , the power dissipated in the load needs to be subtracted from the total power delivered by the supplies.

$$P_D = P_{\text{Supply}} - P_{\text{Load}}$$

Supply power is calculated by the standard power equation.

$$P_{\text{Supply}} = V_{\text{Supply}} \times I_{\text{RMSSupply}}$$

$$V_{\text{Supply}} = V_{S+} - V_{S-}$$

Power delivered to a purely resistive load is:

$$P_{\text{Load}} = ((V_{\text{Load}})_{\text{RMS}})^2 / R_{\text{LoadEff}}$$

The effective load resistor ( $R_{\text{LoadEff}}$ ) will need to include the effect of the feedback network. For instance,

$R_{\text{LoadEff}}$  in Figure 3 would be calculated as:

$$R_L \parallel (R_f + R_g)$$

These measurements are basic and are relatively easy to perform with standard lab equipment. For design purposes however, prior knowledge of actual signal levels and load impedance is needed to determine the dissipated power. Here,  $P_D$  can be found from

$$P_D = P_{\text{Quiescent}} + P_{\text{Dynamic}} - P_{\text{Load}}$$

Quiescent power can be derived from the specified  $I_S$  values along with known supply voltage,  $V_{\text{Supply}}$ . Load power can be calculated as above with the desired signal amplitudes using:

$$(V_{\text{Load}})_{\text{RMS}} = V_{\text{peak}} / \sqrt{2}$$

$$(I_{\text{Load}})_{\text{RMS}} = (V_{\text{Load}})_{\text{RMS}} / R_{\text{LoadEff}}$$

The dynamic power is focused primarily within the output stage driving the load. This value can be calculated as:

$$P_{\text{Dynamic}} = (V_{S+} - V_{\text{Load}})_{\text{RMS}} \times (I_{\text{Load}})_{\text{RMS}}$$

Assuming the load is referenced in the middle of the power rails or  $V_{\text{Supply}}/2$ .

The XR8051 is short circuit protected. However, this may not guarantee that the maximum junction temperature (+150°C) is not exceeded under all conditions. Figure 6 shows the maximum safe power dissipation in the package vs. the ambient temperature for the packages available.

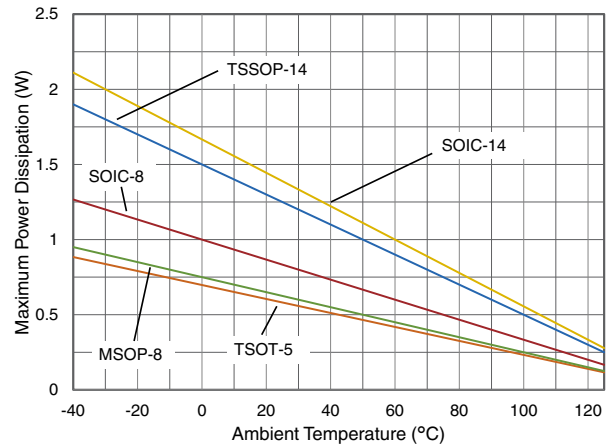


Figure 6. Maximum Power Derating

**Driving Capacitive Loads**

Increased phase delay at the output due to capacitive loading can cause ringing, peaking in the frequency response, and possible unstable behavior. Use a series resistance,  $R_S$ , between the amplifier and the load to help improve stability and settling performance. Refer to Figure 7.

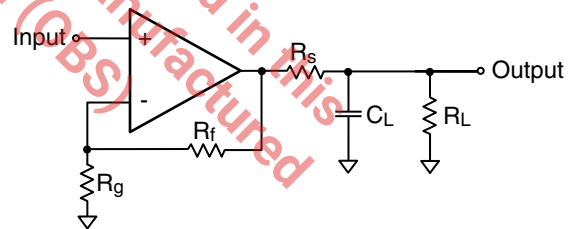


Figure 7. Addition of  $R_S$  for Driving Capacitive Loads

Table 1 provides the recommended  $R_S$  for various capacitive loads. The recommended  $R_S$  values result in approximately <1dB peaking in the frequency response.

$C_L$ (pF)	$R_S$ ( $\Omega$ )	-3dB BW (MHz)
22pF	0	120
47pF	15	80
100pF	15	65
492pF	6.5	40

Table 1: Recommended  $R_S$  vs.  $C_L$

For a given load capacitance, adjust  $R_S$  to optimize the tradeoff between settling time and bandwidth. In general, reducing  $R_S$  will increase bandwidth at the expense of additional overshoot and ringing.

**Layout Considerations**

General layout and supply bypassing play major roles in high frequency performance. Exar has evaluation boards to use as a guide for high frequency layout and as an aid in device testing and characterization. Follow the steps below as a basis for high frequency layout:

- Include 6.8 $\mu$ F and 0.1 $\mu$ F ceramic capacitors for power supply decoupling
- Place the 6.8 $\mu$ F capacitor within 0.75 inches of the power pin
- Place the 0.1 $\mu$ F capacitor within 0.1 inches of the power pin
- Remove the ground plane under and around the part, especially near the input and output pins to reduce parasitic capacitance
- Minimize all trace lengths to reduce series inductances

Refer to the evaluation board layouts below for more information.

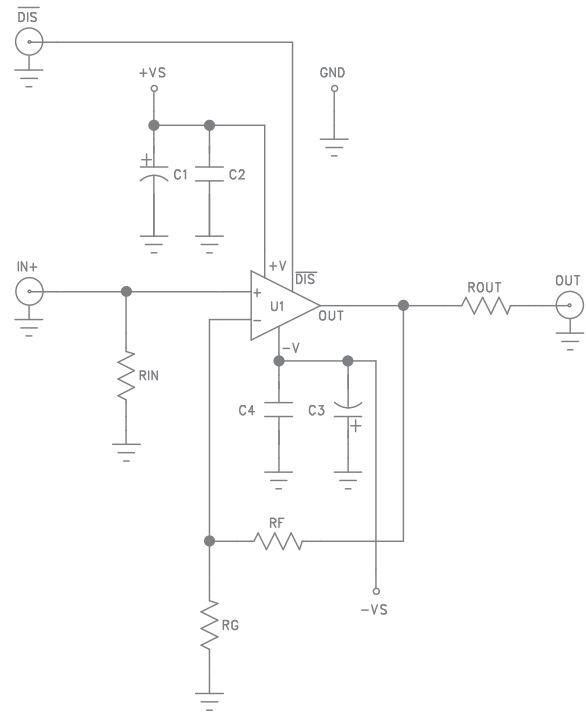


Figure 8. CEB002 & CEB003 Schematic

**Evaluation Board Information**

The following evaluation boards are available to aid in the testing and layout of these devices:

Evaluation Board #	Products
CEB002	XR8051 in TSOT
CEB003	XR8051 in SOIC
CEB006	XR8052 in SOIC
CEB010	XR8052 in MSOP
CEB018	XR8054 in TSSOP

**Evaluation Board Schematics**

Evaluation board schematics and layouts are shown in Figures 8-14. These evaluation boards are built for dual-supply operation. Follow these steps to use the board in a single-supply application:

1. Short  $-V_S$  to ground.
2. Use C3 and C4, if the  $-V_S$  pin of the amplifier is not directly connected to the ground plane.

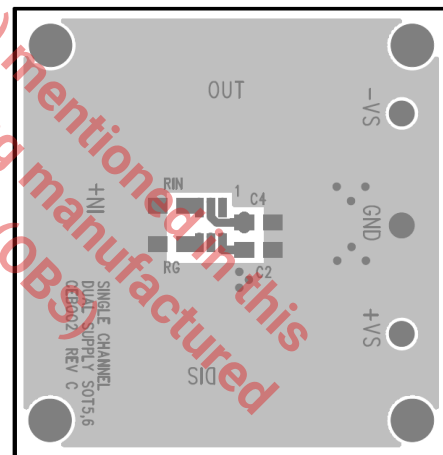


Figure 9. CEB002 Top View

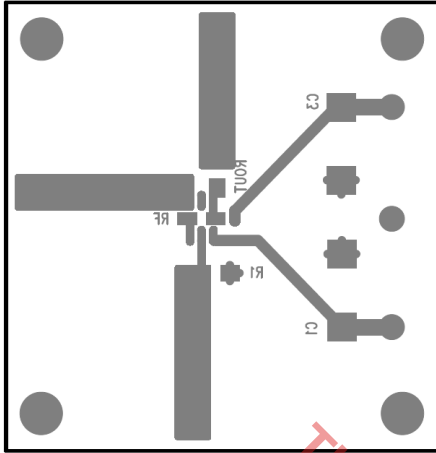


Figure 10. CEB002 Bottom View

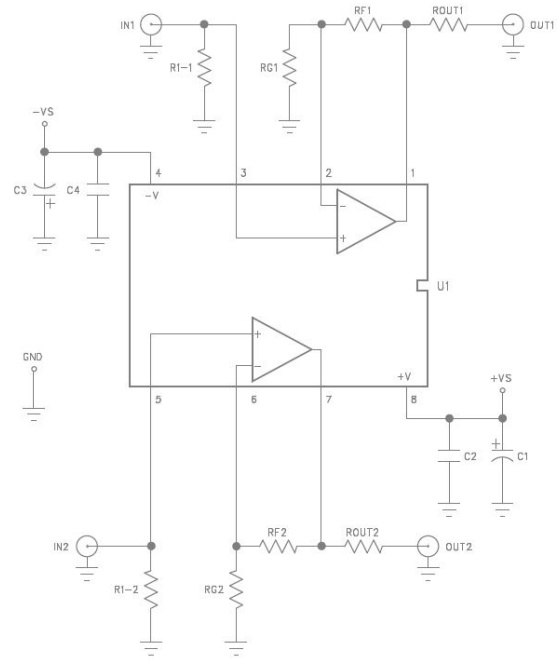


Figure 13. CEB006 & CEB010 Schematic

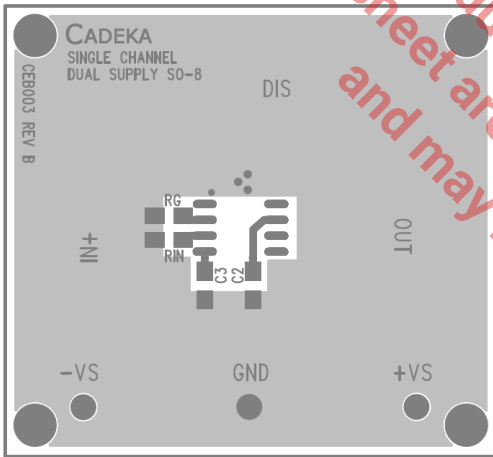


Figure 11. CEB003 Top View

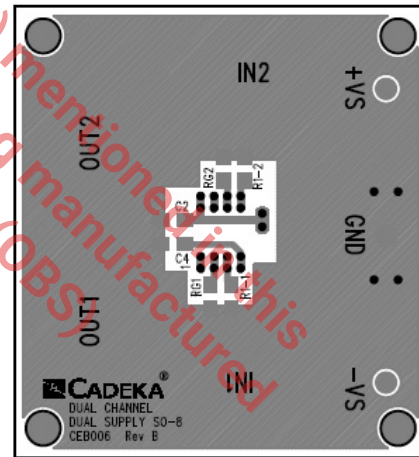


Figure 14. CEB006 Top View

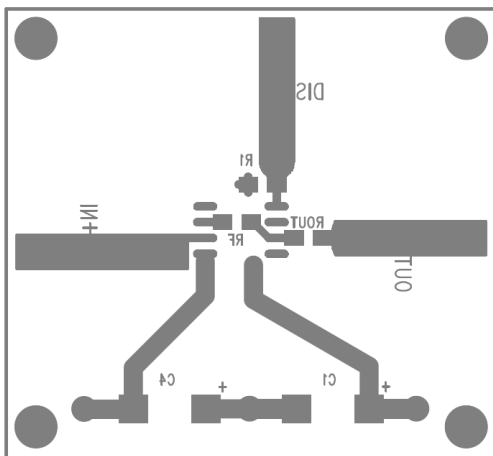


Figure 12. CEB003 Bottom View

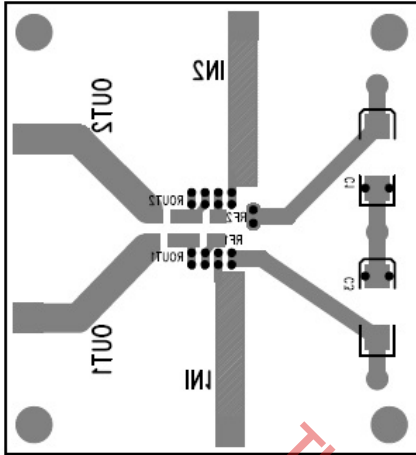


Figure 15. CEB006 Bottom View

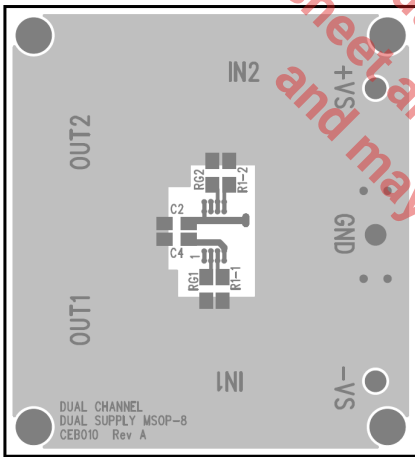


Figure 16. CEB010 Top View

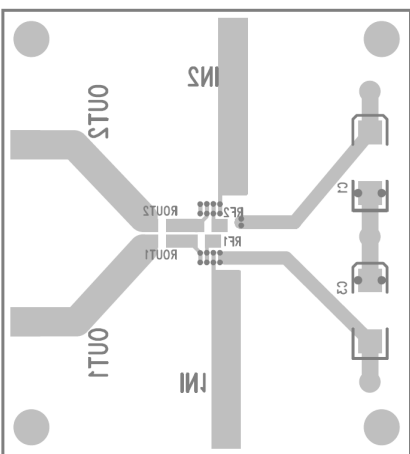


Figure 17. CEB010 Bottom View

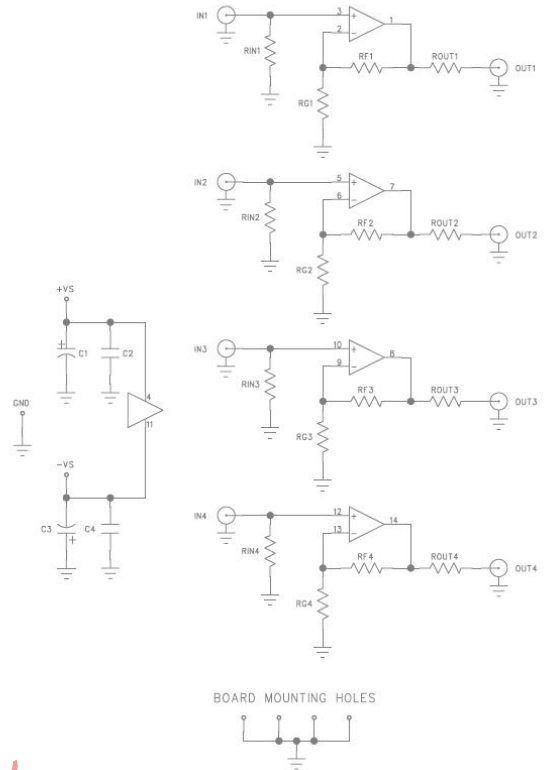


Figure 18. CEB018 Schematic

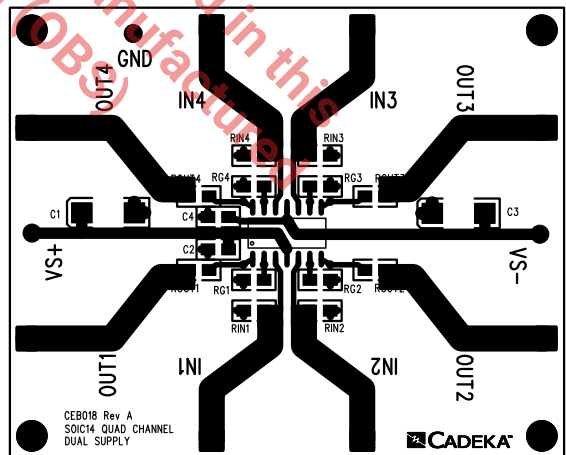


Figure 19. CEB018 Top View

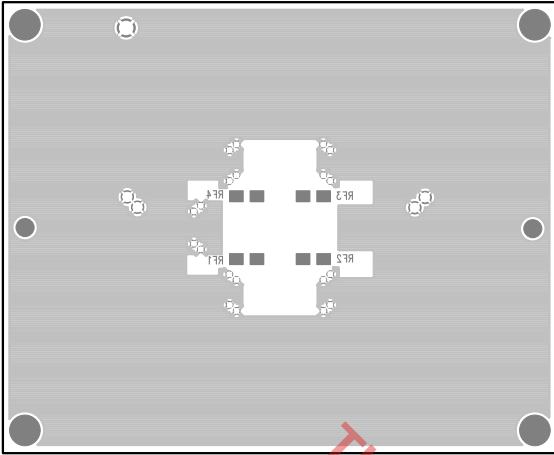
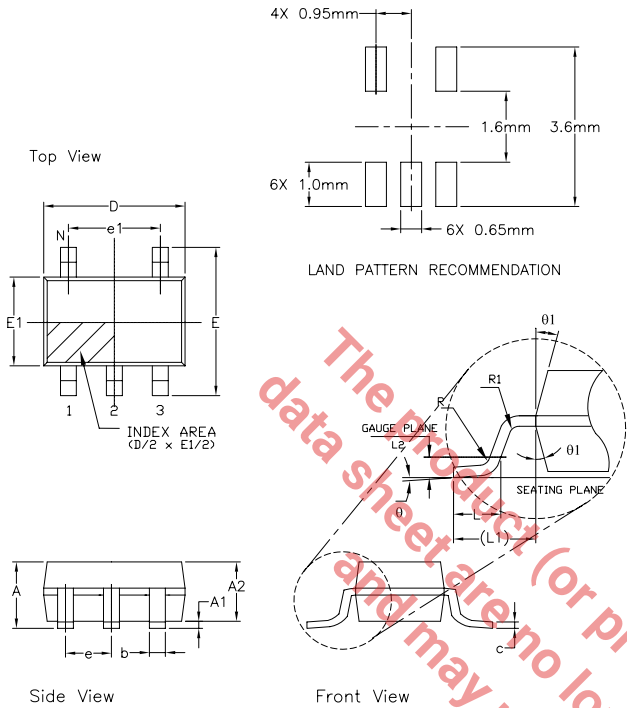


Figure 20. CEB018 Bottom View

The product (or products) mentioned in this data sheet are no longer being manufactured and may not be ordered (OBS)

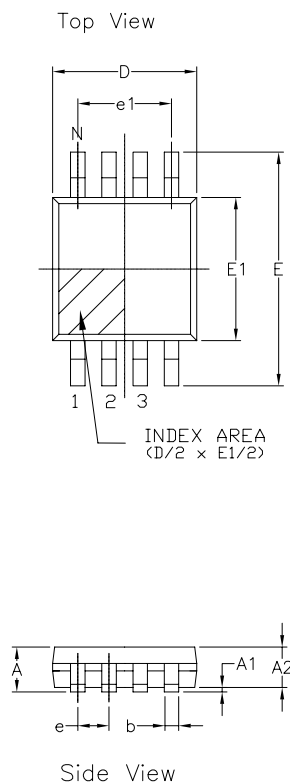
Mechanical Dimensions

TSOT-5 Package

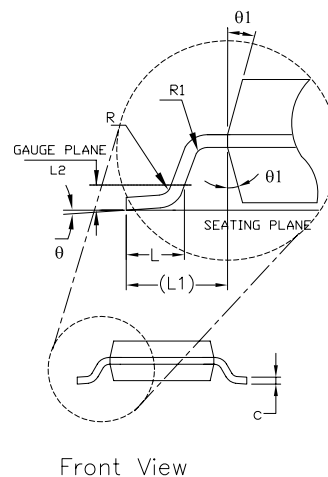


5 Pin TSOT (OPTION 2)						
SYMBOLS	DIMENSION IN MM (Control Unit)			DIMENSION IN INCH (Reference Unit)		
	MIN	NOM	MAX	MIN	NOM	MAX
A	0.75	—	0.80	0.030	—	0.031
A1	0.00	—	0.05	0.000	—	0.002
A2	0.70	0.75	0.78	0.028	0.030	0.031
b	0.35	—	0.50	0.012	—	0.020
c	0.10	—	0.20	0.003	—	0.008
D	2.90 BSC			0.114 BSC		
E	2.80 BSC			0.110 BSC		
E1	1.60 BSC			0.063 BSC		
e	0.95 BSC			0.038 BSC		
e1	1.90 BSC			0.075 BSC		
L	0.37	0.45	0.60	0.012	0.018	0.024
L1	0.60 REF			0.024 REF		
L2	0.25 BSC			0.010 BSC		
R	0.10	—	—	0.004	—	—
R1	0.10	—	0.25	0.004	—	0.010
θ	0°	4°	8°	0°	4°	8°
θ1	4°	10°	12°	4°	10°	12°
N	5			5		

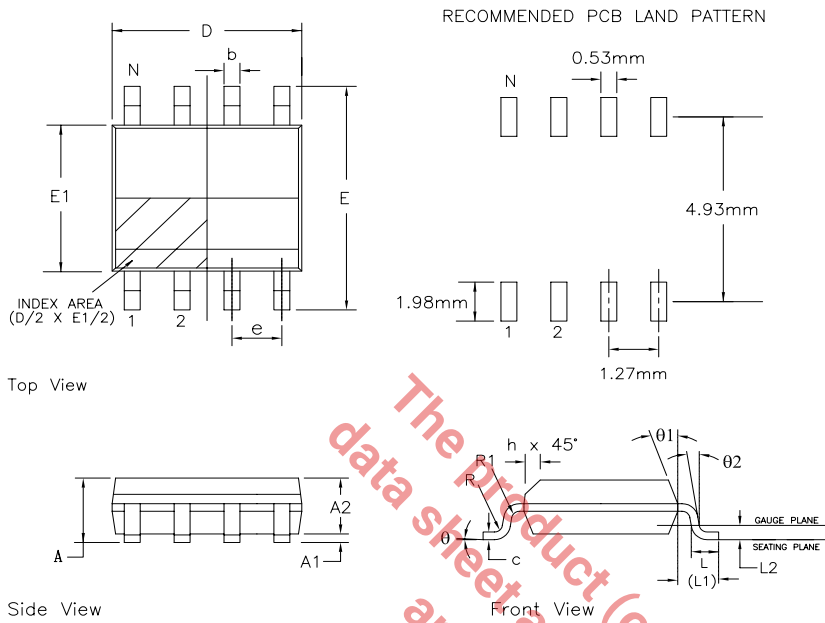
MSOP-8 Package



8 Pin MSOP JEDEC MO-187 Variation AA						
SYMBOLS	DIMENSIONS IN MM (Control Unit)			DIMENSIONS IN INCH (Reference Unit)		
	MIN	NOM	MAX	MIN	NOM	MAX
A	—	—	1.10	—	—	0.043
A1	0.00	—	0.15	0.000	—	0.006
A2	0.75	0.85	0.95	0.030	0.033	0.037
b	0.22	—	0.38	0.009	—	0.015
c	0.08	—	0.23	0.003	—	0.009
E	4.90 BSC			0.193 BSC		
E1	3.00 BSC			0.118 BSC		
e	0.63 BSC			0.026 BSC		
e1	0.95 BSC			0.077 BSC		
L	0.40	0.60	0.80	0.016	0.024	0.031
L1	0.95 REF			0.037 REF		
L2	0.25 BSC			0.010 BSC		
R	0.07	—	—	0.003	—	—
R1	0.07	—	—	0.003	—	—
θ	0°	—	8°	0°	—	8°
θ1	5°	—	15°	5°	—	15°
D	3.00 BSC			0.118 BSC		
N	8			8		

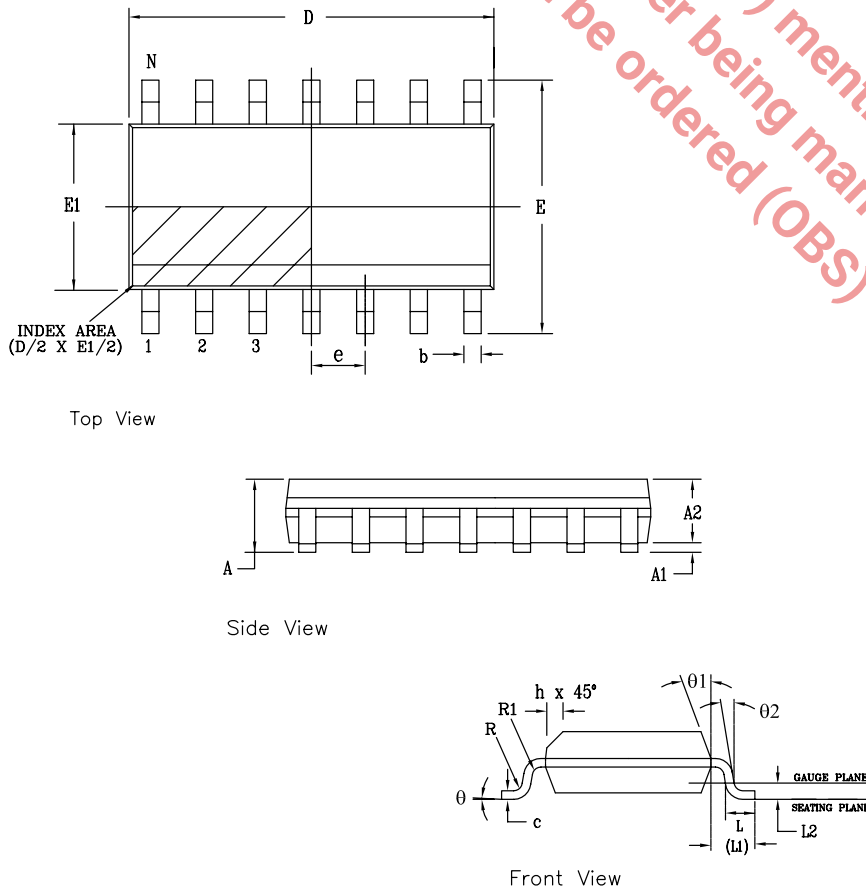


SOIC-8 Package



8 Pin SOICN JEDEC MS-012 Variation AA						
SYMBOLS	DIMENSIONS IN MM (Control Unit)			DIMENSIONS IN INCH (Reference Unit)		
	MIN	NOM	MAX	MIN	NOM	MAX
A	1.35	—	1.75	0.053	—	0.069
A1	0.10	—	0.25	0.004	—	0.010
A2	1.25	—	1.65	0.049	—	0.065
b	0.31	—	0.51	0.012	—	0.020
c	0.17	—	0.25	0.007	—	0.010
E	6.00 BSC			0.236 BSC		
E1	3.90 BSC			0.154 BSC		
e	1.27 BSC			0.050 BSC		
h	0.25	—	0.50	0.010	—	0.020
L	0.40	—	1.27	0.016	—	0.050
L1	1.04 REF			0.041 REF		
L2	0.25 BSC			0.010 BSC		
R	0.07	—	—	0.003	—	—
R1	0.07	—	—	0.003	—	—
θ	0°	—	8°	0°	—	8°
θ1	5°	—	15°	5°	—	15°
θ2	0°	—	—	0°	—	—
D	4.90 BSC			0.193 BSC		
N	8			8		

SOIC-14 Package

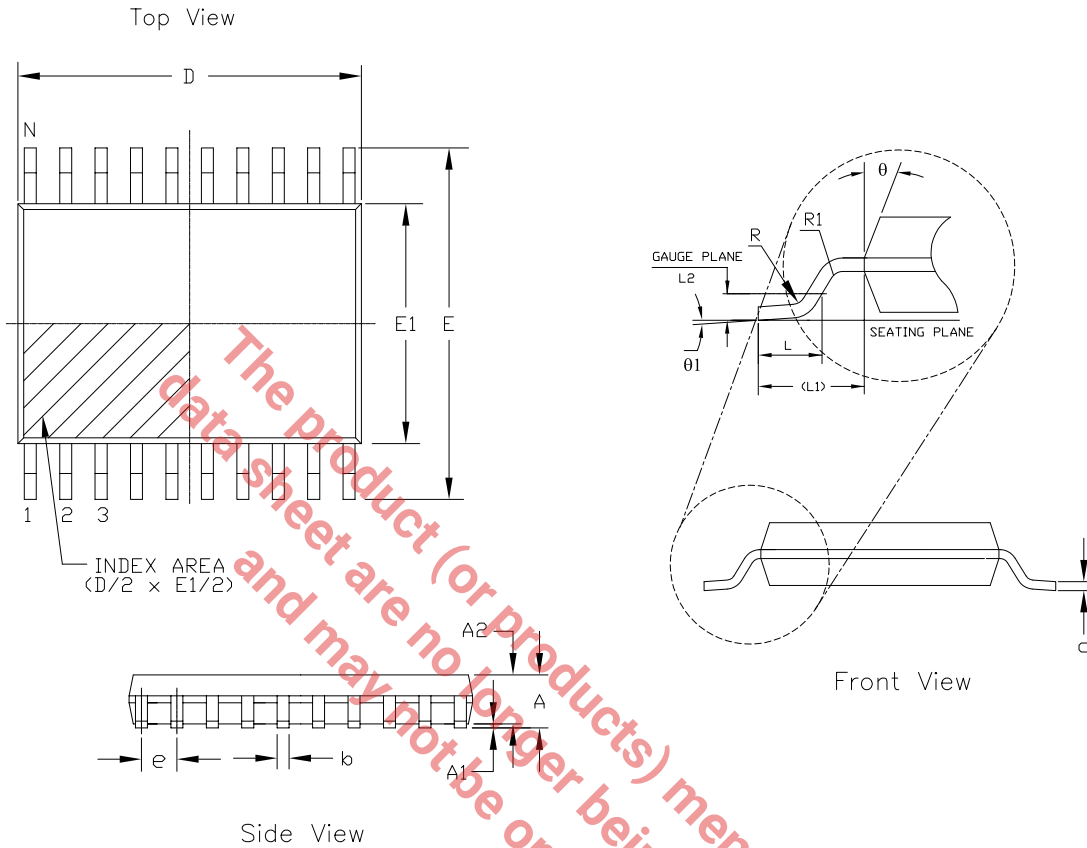


PACKAGE OUTLINE NSOIC .150" BODY JEDEC MS-012						
SYMBOLS	COMMON DIMENSIONS IN MM (Control Unit)			COMMON DIMENSIONS IN INCH (Reference Unit)		
	MIN	NOM	MAX	MIN	NOM	MAX
A	1.35	—	1.75	0.053	—	0.069
A1	0.10	—	0.25	0.004	—	0.010
A2	1.25	—	1.65	0.049	—	0.065
b	0.31	—	0.51	0.012	—	0.020
c	0.17	—	0.25	0.007	—	0.010
E	6.00 BSC			0.236 BSC		
E1	3.90 BSC			0.154 BSC		
e	1.27 BSC			0.050 BSC		
h	0.25	—	0.50	0.010	—	0.020
L	0.40	—	1.27	0.016	—	0.050
L1	1.04 REF			0.041 REF		
L2	0.25 BSC			0.010 BSC		
R	0.07	—	—	0.003	—	—
R1	0.07	—	—	0.003	—	—
θ	0°	—	8°	0°	—	8°
θ1	5°	—	15°	5°	—	15°
θ2	0°	—	—	0°	—	—
D	SEE VARIATIONS					
N	SEE VARIATIONS					

VARIATION D							
VARIATIONS	DIMENSIONS IN MM (Control Unit)			DIMENSIONS IN INCH (Reference Unit)			N
	MIN	NOM	MAX	MIN	NOM	MAX	
AA	4.90	BSC	—	0.193	BSC	—	8
AB	8.65	BSC	—	0.341	BSC	—	14
AC	9.90	BSC	—	0.390	BSC	—	16



TSSOP-14 Package



14 Pin TSSOP JEDEC MO-153 Variation AB-1

SYMBOLS	DIMENSIONS IN MM (Control Unit)			DIMENSIONS IN INCH (Reference Unit)		
	MIN	NOM	MAX	MIN	NOM	MAX
A	—	—	1.20	—	—	0.047
A1	0.05	—	0.15	0.002	—	0.006
A2	0.80	1.00	1.05	0.031	0.039	0.041
b	0.19	—	0.30	0.007	—	0.012
c	0.09	—	0.20	0.004	—	0.008
E	6.40 BSC			0.252 BSC		
E1	4.30	4.40	4.50	0.169	0.173	0.177
e	0.65 BSC			0.026 BSC		
L	0.45	0.60	0.75	0.018	0.024	0.030
L1	1.00 REF			0.039 REF		
L2	0.25 BSC			0.010 BSC		
R	0.09	—	—	0.035	—	—
R1	0.09	—	—	0.035	—	—
$\theta$	12° REF			12° REF		
$\theta1$	0°	—	8°	0°	—	8°
D	4.90	5.00	5.10	0.193	0.197	0.200
N	14			14		

## Ordering Information

Part Number	Package	Green	Operating Temperature Range	Packaging
XR8051 Ordering Information				
XR8051AST5X	TSOT-5	Yes	-40°C to +125°C	Tape & Reel
XR8051AST5MTR	TSOT-5	Yes	-40°C to +125°C	Tape & Reel
XR8051AST5EVB	Evaluation Board	N/A	N/A	N/A
XR8051ASO8X	SOIC-8	Yes	-40°C to +125°C	Tape & Reel
XR8051ASO8MTR	SOIC-8	Yes	-40°C to +125°C	Tape & Reel
XR8051ASO8EVB	Evaluation Board	N/A	N/A	N/A
XR8052 Ordering Information				
XR8052ASO8X	SOIC-8	Yes	-40°C to +125°C	Tape & Reel
XR8052ASO8MTR	SOIC-8	Yes	-40°C to +125°C	Tape & Reel
XR8052ASO8EVB	Evaluation Board	N/A	N/A	N/A
XR8052AMP8X	MSOP-8	Yes	-40°C to +125°C	Tape & Reel
XR8052AMP8MTR	MSOP-8	Yes	-40°C to +125°C	Tape & Reel
XR8052AMP8EVB	Evaluation Board	N/A	N/A	N/A
XR8054 Ordering Information				
XR8054ATP14X	TSSOP-14	Yes	-40°C to +125°C	Tape & Reel
XR8054ATP14MTR	TSSOP-14	Yes	-40°C to +125°C	Tape & Reel
XR8054ATP14EVB	Evaluation Board	N/A	N/A	N/A
XR8054ASO14X	SOIC-14	Yes	-40°C to +125°C	Tape & Reel
XR8054ASO14MTR	SOIC-14	Yes	-40°C to +125°C	Tape & Reel
XR8054ASO14EVB	Evaluation Board	N/A	N/A	N/A

Moisture sensitivity level for all parts is MSL-1. Mini tape and reel quantity is 250.

## Revision History

Revision	Date	Description
1B (ECN 1451-05)	December 2014	Reformat into Exar data sheet template. Updated ordering information table to include MTR and EVB part numbers. Updated thermal resistance numbers and package outline drawings. Updated typical small signal bandwidth specifications and plots.

*The product (or products) mentioned in this data sheet are no longer being manufactured and may not be ordered (OBS)*

For Further Assistance:

Email: [CustomerSupport@exar.com](mailto:CustomerSupport@exar.com) or [HPATechSupport@exar.com](mailto:HPATechSupport@exar.com)

Exar Technical Documentation: <http://www.exar.com/techdoc/>

**Exar Corporation Headquarters and Sales Offices**

48760 Kato Road  
Fremont, CA 94538 - USA

Tel.: +1 (510) 668-7000  
Fax: +1 (510) 668-7001



A New Direction in Mixed-Signal

**NOTICE**

EXAR Corporation reserves the right to make changes to the products contained in this publication in order to improve design, performance or reliability. EXAR Corporation assumes no responsibility for the use of any circuits described herein, conveys no license under any patent or other right, and makes no representation that the circuits are free of patent infringement. Charts and schedules contained here in are only for illustration purposes and may vary depending upon a user's specific application. While the information in this publication has been carefully checked; no responsibility, however, is assumed for inaccuracies.

EXAR Corporation does not recommend the use of any of its products in life support applications where the failure or malfunction of the product can reasonably be expected to cause failure of the life support system or to significantly affect its safety or effectiveness. Products are not authorized for use in such applications unless EXAR Corporation receives, in writing, assurances to its satisfaction that: (a) the risk of injury or damage has been minimized; (b) the user assumes all such risks; (c) potential liability of EXAR Corporation is adequately protected under the circumstances.

Reproduction, in part or whole, without the prior written consent of EXAR Corporation is prohibited.